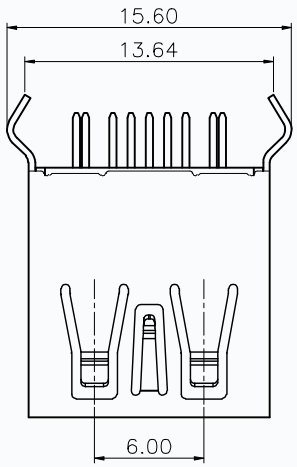
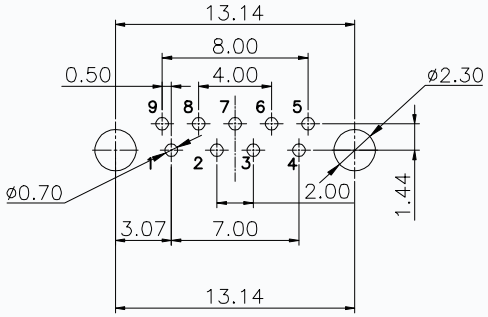
REV.	ECN NO.	DESCRIPTION	DRAW	CHECK	APPD.	DATE
A0	—	NEW DWG	BENDEE	—	—	2016.8.23



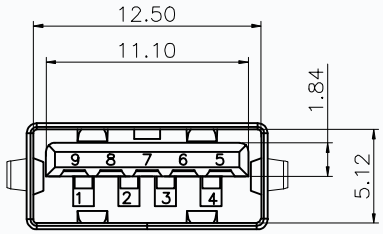


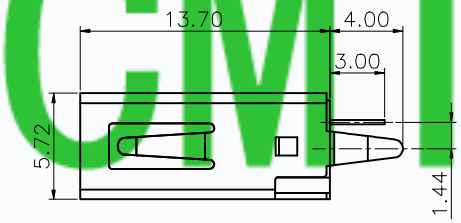
NOTES:

1. MATERIAL:
- 1.1 HOUSING: HIGIH TEMPERATURATURE THERAL PLASTIC.
- 1.2 SPRING CONTACT: COPPER ALLOY.
- 1.3 FLAT CONTACT;COPPER ALLOY
- 1.4 SHELL :COPPER ALLOY.
- 1.5 COVER:HIGIH TEMPERATURATURE THERAL PLASTIC.

2. FINISH:
- 2.1 CONTACT: (SEE P/N.),[50m"] MIN. NICKEL UNDERPLATING OVER ALL.
- 2.2 SHELL: [50m"] MIN.SOLDERABLITY NICKEL UNDERPLATING OVER ALL.

CMTDDZ





料号备注

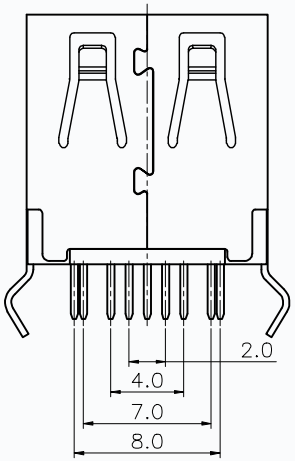
T10-	3	F	224	D	XX	T	XX	X	X

- 12=半金雾锡10"
- 13=半金雾锡30"
- 14=半金雾锡50"
- 15=半金雾锡150"
- 16=半金雾锡300"

00=LCP蓝色

R=ROHS2.0标准
W=无卤+ROHS2.0
H=REACH标准

B=盐雾24H
C=盐雾48H



PIN NO.	PIN 1	PIN 2	PIN 3	PIN 4
SLGNAL NAME	V BUS	D−	D+	GND
REMARK	USB 2.0 CONTACT PINS			

PIN NO.	PIN 5	PIN 6	PIN 7	PIN 8	PIN 9
SLGNAL NAME	STDA_SSRX−	STDA_SSRX+	GND_DRAIN	STDA_SSTX−	STDA_SSTX+
REMARK	USB 3.0 CONTACT PINS				

东 莞 市 田 都 电 子 有 限 公 司
Dong Guan TianDu Electronics Co.,Ltd

UNLESS OTHERWISE SPECIFIED TOLERANCES

	METRIC
X. +/−	0.30
.X +/−	0.25
.XX +/−	0.25
FRACTIONS +/−	
ANGLES +/−	2.00°

APPROVAL		日期
制图	BENDEE	2016.8.23
审核		
核准		

ANGLE | DIMENSIONS (METRIC) (MM)

品名规格	USB 3.0 AF 180度插板13.7 [无卷边]		
料号	SEE TABLE		
图号	DWG-USBAF-284	版本:	A0
比例	1:1	状态码 A	页数 1 OF 1